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GaAs MMIC SMT DOUBLE-BALANCED MIXER, 2.5 - 4 GHz



Typical Applications

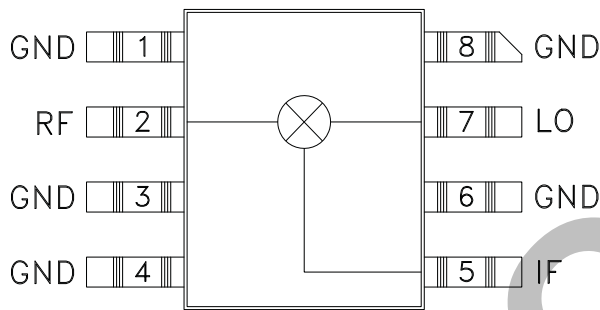
The HMC170C8 is ideal for:

- Microwave Point-to-Point
- RADAR
- VSAT

Features

- Conversion Loss: 9. dB
- LO to RF Isolation: 45 dB
- Surface Mount
- Small Size, No DC Bias Required

Functional Diagram



General Description

The HMC170C8 is a miniature double-balanced mixer in a non-hermetic ceramic surface mount package that can be used as an upconverter, downconverter or biphase modulator. The device is a passive diode/balun type mixer with high dynamic range. Noise figure is essentially equal to the conversion loss. The mixer can handle larger signal levels than most active mixers due to the high third order intercept. MMIC implementation provides exceptional balance in the circuit resulting in high LO/RF and LO/IF isolations and unit-to-unit consistency. This mixer has applications where small size and surface mount compatibility are important.

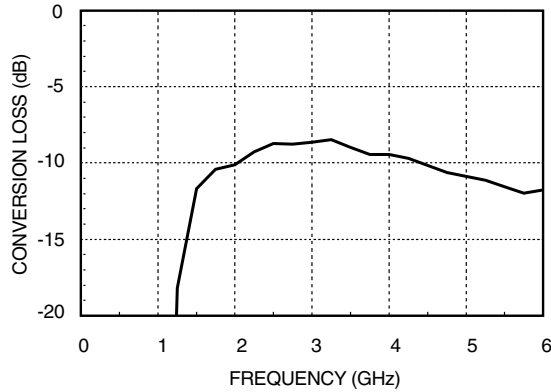
Electrical Specifications, $T_A = +25^\circ\text{C}$, LO Drive = +13 dBm

Parameter	Min.	Typ.	Max.	Units
Frequency Range, RF & LO	2.5 - 4.0			GHz
Frequency Range, IF	DC - 2			GHz
Conversion Loss		9	10	dB
Noise Figure (SSB)		9	10	dB
LO to RF Isolation	40	45		dB
LO to IF Isolation	32	36		dB
IP3 (Input)	13	18		dBm
IP2 (Input)	35	40		dBm
1 dB Gain Compression (Input)	7	10		dBm

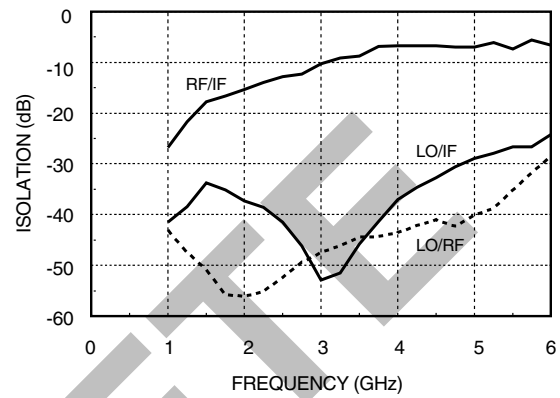


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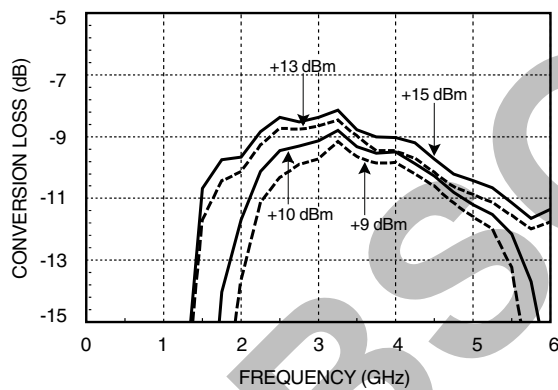
Conversion Loss



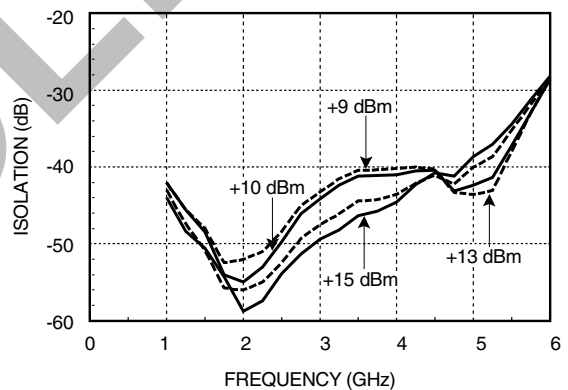
Isolation



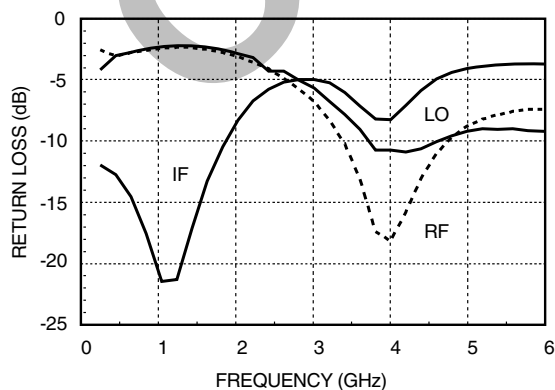
Conversion Loss vs. LO Drive



Isolation vs. LO Drive



Return Loss



Distortion and 1dB Compression vs. LO Drive Level

LO Drive (dBm)	Distortion		1 dB Compression P1dB (dBm)
	IP3 (dBm)	IP2 (dBm)	
+10	16	38	8
+13	18	40	10
+15	18	40	10

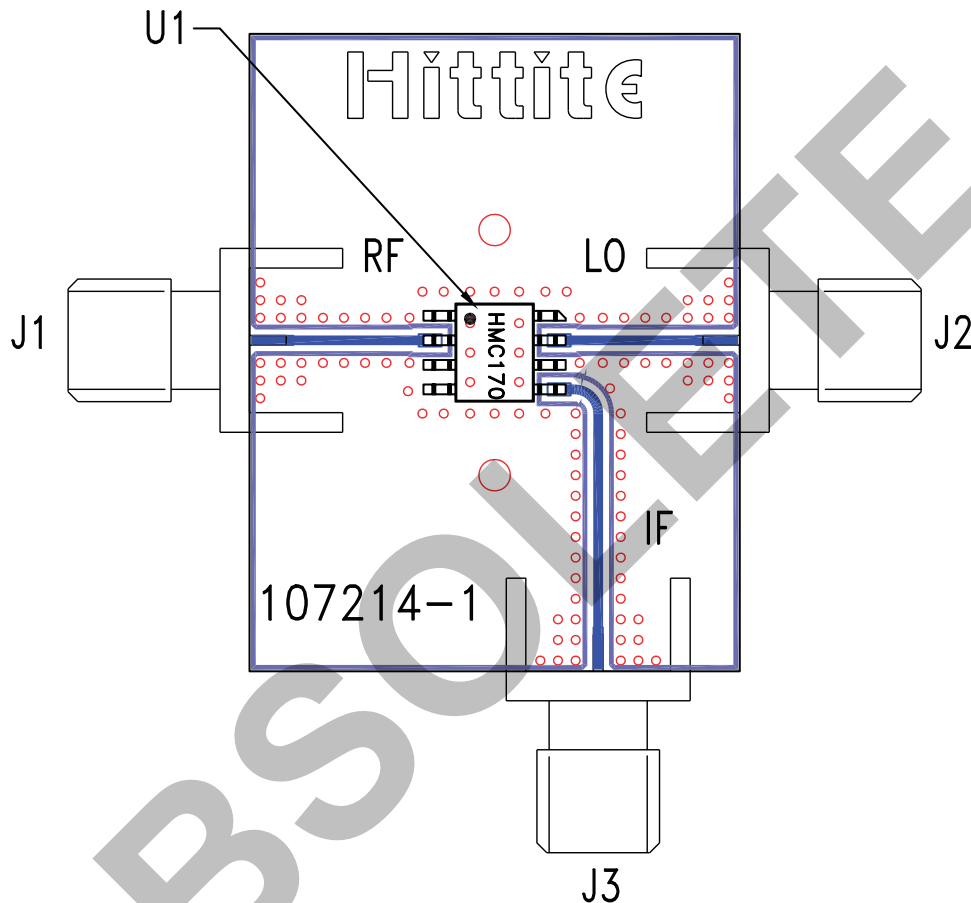
S - Parameters for the RF, LO, IF Ports are Available On-Line at www.hittite.com

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Evaluation PCB



List of Materials for Evaluation PCB 102102 [1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
U1	HMC170C8 Mixer
PCB [2]	107214 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.